RoHS

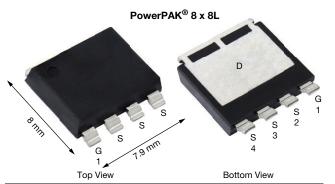
COMPLIANT

HALOGEN FREE

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Vishay Siliconix

N-Channel 150 V (D-S) 175 °C MOSFET



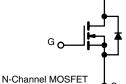
PRODUCT SUMMARY						
V _{DS} (V)	150					
$R_{DS(on)}$ max. (Ω) at V_GS = 10 V	0.0041					
$R_{DS(on)}$ max. (Ω) at V_GS = 7.5 V	0.0044					
Q _g typ. (nC)	93					
I _D (A) ^a	174					
Configuration	Single					

FEATURES

- TrenchFET[®] Gen V power MOSFET
- Fully lead (Pb)-free device
- Very low R_{DS} x Q_g figure of merit (FOM)
- Up to 174 A maximum continuous drain current
- 50 % smaller footprint than D²PAK (TO-263)
- 100 % R_{α} and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- OR-ing
- Motor drive control
- Battery management



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ORDERING INFORMATION	
Package	PowerPAK 8 x 8L
Lead (Pb)-free and halogen-free	SIJH5700E-T1-GE3

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	150	v	
Gate-source voltage		V _{GS}	±20		
	T _C = 25 °C		174		
	T _C = 70 °C	Ι. Γ	138		
Continuous drain current (T _J = 175 °C)	T _A = 25 °C	ID	17 ^b		
	T _A = 70 °C		15 ^b	Α	
Pulsed drain current (t = 100 µs)	•	I _{DM}	500	A	
Continuous courses drein diada current	T _C = 25 °C		303		
Continuous source-drain diode current	T _A = 25 °C	I _S	3 b		
Single pulse avalanche current L = 0.1 mH		I _{AS}	40		
Single pulse avalanche energy		E _{AS}	80	mJ	
	T _C = 25 °C		333		
Maximum power dissipation	T _C = 70 °C		233	w	
Maximum power dissipation	T _A = 25 °C	P _D	3.3 ^b	vv	
	T _A =70 °C		2.3 ^b		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak tempera		260			

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient ^b	Steady state	R _{thJA}	36	45	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	0.36	0.45	0/11	

Notes

a. $T_C = 25 \ ^{\circ}C$

b. Surface mounted on 1" x 1" FR4 board
c. See solder profile (www.vishay.com/doc?73257). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 1 mA$		-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 10 mA	-	86	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-9.5	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2	-	4	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20$	-	-	100	nA	
Zara gata valtaga drain aurrant		$V_{DS} = 120 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1		
Zero gate voltage drain current	I _{DSS}	V_{DS} = 120 V, V_{GS} = 0 V, T_{J} = 70 °C	-	-	15	μA	
Drain aquraa an atata ragistanga a	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0034	0.0041	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	0.0036	0.0044	52	
Forward transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 70 \text{ A}$	-	175	-	S	
Dynamic ^b							
Input capacitance	apacitance C _{iss}		-	7500	-		
Output capacitance	C _{oss}	V_{DS} = 75 V, V_{GS} = 0 V, f = 1 MHz	-	620	-	pF	
Reverse transfer capacitance	C _{rss}		-	12	620 - 12 - 93 140 70 105 36 - 8 -		
Total gata charge	0	$V_{DS}=75$ V, $V_{GS}=10$ V, $I_{D}=20$ A	-	93	140		
Total gate charge	Qg		-	70	105	nC	
Gate-source charge	Q _{gs}	V_{DS} = 75 V, V_{GS} = 7.5 V, I_{D} = 20 A	-	36	-		
Gate-drain charge	Q _{gd}		-	8	-		
Gate resistance	9		0.36	1.8	3.6	Ω	
Turn-on delay time	t _{d(on)}		-	28	60		
Rise time	tr	V_{DD} = 75 V, R_L = 7.5 Ω , $I_D \cong$ 10 A,	-	20	40		
Turn-off delay time	t _{d(off)}	V_{GEN} = 10 V, R_g = 1 Ω	-	45	90		
Fall time	t _f		-	45	90	ns	
Turn-on delay time	t _{d(on)}		-	24	50	115	
Rise time	t _r	V_{DD} = 75 V, R_L = 7.5 Ω , $I_D \cong$ 10 A,	-	33	70]	
Turn-off delay time	t _{d(off)}	V_{GEN} = 7.5 V, R_g = 1 Ω	-	41	80		
Fall time	t _f		-	46	90		
Drain-Source Body Diode Characteris	tics						
Continuous source-drain diode current	I _S	$T_{C} = 25 \ ^{\circ}C$	-	-	303	Α	
Pulse diode forward current	I _{SM}		-	-	500		
Body diode voltage	V _{SD}	$I_{S} = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	0.75	1.1	V	
Body diode reverse recovery time	t _{rr}		-	197	400	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 10 A, dl/dt = 100 A/μs, T _{.1} = 25 °C	-	1480	2960	nC	
Reverse recovery fall time	t _a	$r_{\rm F} = 10$ A, $u/ut = 100$ A/µs, $r_{\rm J} = 20$ C	-	141	-	200	
Reverse recovery rise time	t _b		-	56	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

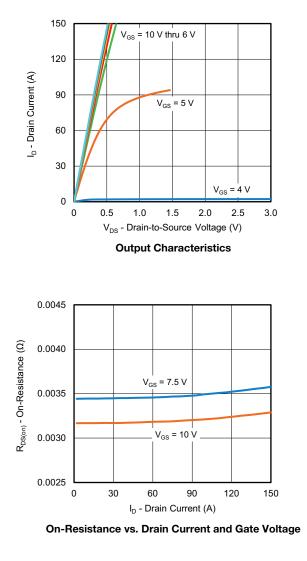
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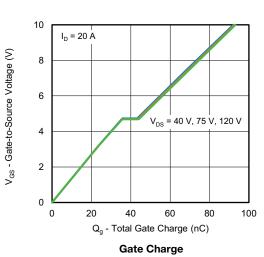
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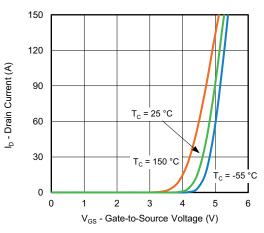


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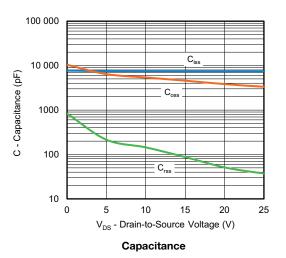
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

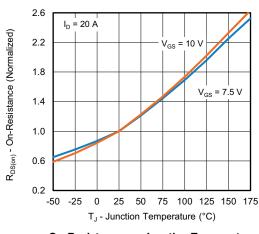






Transfer Characteristics





On-Resistance vs. Junction Temperature

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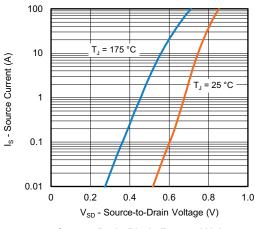
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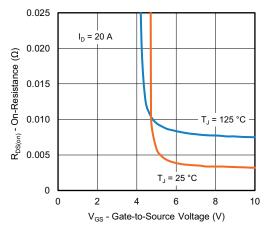


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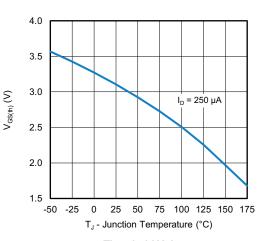
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



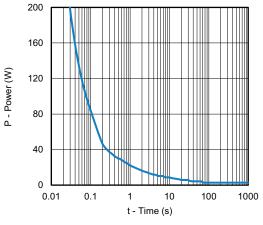
Source-Drain Diode Forward Voltage



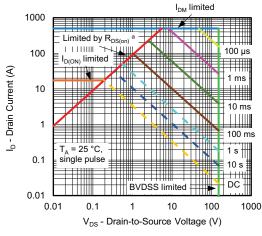
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

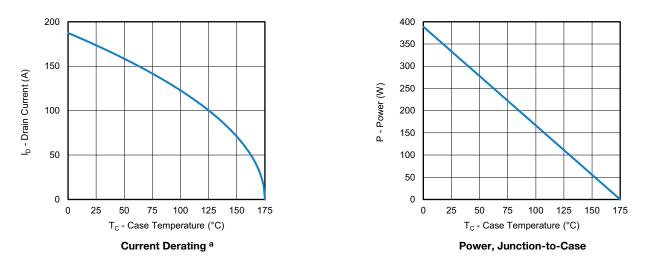
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



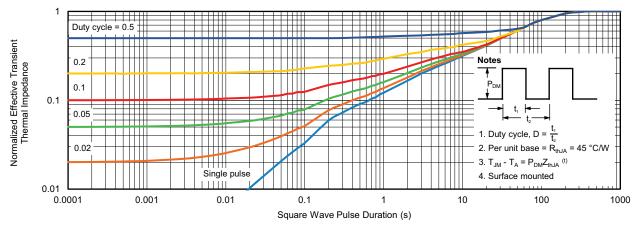
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

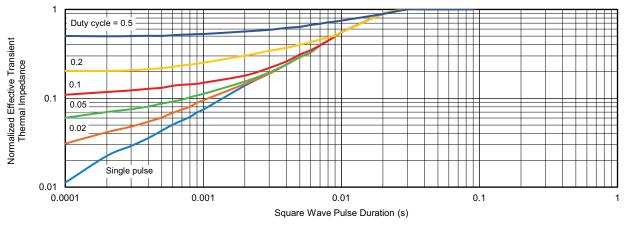


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

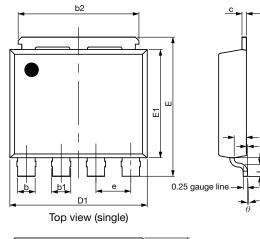
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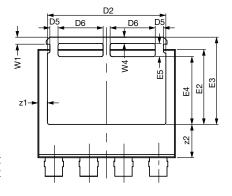
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PowerPAK[®] 8 x 8L BWL Case Outline 2

A1





Bottom view (single)

1					1	- 4	L
F	-				⇒	∢	
							1
~			 L	 			-

DIM.							
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	1.50 1.6		1.70	0.059	0.063	0.067	
A1	0.00	-	0.127	0.000	-	0.005	
A2	0.655	0.705	0.755	0.026	0.028	0.030	
b	0.92	1.00	1.08	0.036	0.039	0.043	
b1	1.02	1.10	1.18	0.040	0.043	0.046	
b2	6.84	6.94	7.04	0.269	0.273	0.277	
С	0.20	0.25	0.30	0.008	0.010	0.012	
D1	7.80	7.90	8.00	0.307	0.311	0.315	
D2	6.70	6.80	6.90	0.264	0.268	0.272	
D5	0.37	0.47	0.57	0.015	0.019	0.022	
D6	2.49	2.59	2.69	0.098	0.102	0.106	
е	1.97	2.00	2.03	0.078	0.079	0.080	
E	7.90	8.00	8.10	0.311	0.315	0.319	
E1	6.12	6.22	6.32	0.241	0.245	0.249	
E2	4.21	4.31	4.41	0.166	0.170	0.174	
E3 4.92		5.02	5.12	0.194	0.198	0.202	
E4	3.80	3.80	3.90	4.00	0.150	0.154	0.157
E5	0.65	0.75	0.85	0.026	0.030	0.033	
L	0.61	0.68	0.75	0.024	0.027	0.030	
L1	1.00	1.07	1.15	0.039	0.042	0.045	
W1	0.30	0.40	0.50	0.012	0.016	0.020	
W4	0.32	0.37	0.42	0.013	0.015	0.017	
z1	0.45	0.55	0.65	0.018	0.022	0.026	
z2	1.81	1.91	2.01	0.071	0.075	0.079	
θ	0°	-	5°	0°	-	5°	

Note

Millimeter will govern

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